TOSHIBA Photocoupler Photorelay

TLP4206G

PBX

Telecommunication

Modem·FAX Cards, Modems In PC

Measurement Instrumentation

The TOSHIBA TLP4206G consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface mount assembly.

The TLP4206G is a 2-form-B switch, which is suitable for replacement of mechanical relays in many applications.

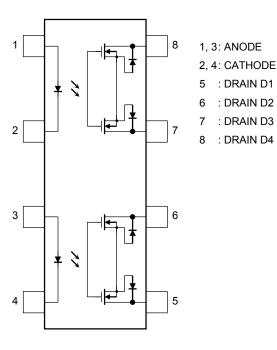
• 8 pin SOP (2.54SOP8): 2.1 mm high, 2.54 mm pitch

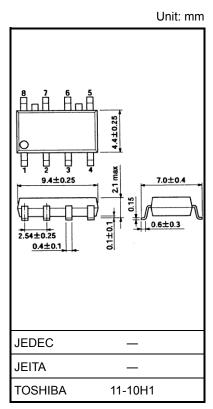
• 2-form-B

Peak off-state voltage: 350 V (min)
Trigger LED current: 3 mA (max)
On-state current: 120 mA (max)
On-state resistance: 25 Ω (max)

Isolation voltage: 1500 Vrms (min)UL approved: UL1577, File No.E67349

Pin Configuration (top view)





Weight: 0.2 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

	Characteristics	Symbol	Rating	Unit
	Forward current	lF	50	mA
	Forward current derating (Ta ≥ 25°C)	Δl _F /°C	-0.5	mA/°C
	Peak forward current (100 µs pulse, 100 pps)	I _{FP}	1	А
E	Reverse voltage	V_{R}	5	V
	Diode power dissipation	P _D	50	mW
	Diode power dissipation derating (Ta ≥ 25°C)	ΔP _D /°C	-0.5	mW/°C
	Junction temperature	Tj	125	°C
	Off-state output terminal voltage	Voff	350	V
	On-state current	ION	120	mA
Detector	On-state current derating (Ta ≥ 25°C)	Δl _{ON} /°C	-1.2	mA/°C
Dete	Output power dissipation	Po	324	mW
	Output power dissipation derating (Ta ≥ 25°C)	ΔP _O /°C	-3.24	mW / °C
	Junction temperature	Tj	125	°C
Ope	rating temperature range	T _{opr}	-40 to 85	°C
Stora	age temperature range	T _{stg}	-55 to 125	°C
Lead	d soldering temperature (10 s)	T _{sol}	260	°C
	ntion voltage 1 minute, R.H. ≤ 60%) (Note 1)	BVS	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: LED side pins shorted together, and DETECTOR side pins shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V_{DD}	_	_	280	V
Forward current	lF	5	_	25	mA
On-state current	Ion	_	_	120	mA
Operating temperature	T _{opr}	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	IR	V _R = 5 V	_	_	10	μA
	Capacitance	CT	V _F = 0 V, f = 1 MHz		30	_	pF
Detector	Off-state current	loff	V _{OFF} = 350 V, I _F = 5 mA		_	1	μΑ
	Capacitance	C _{OFF}	V = 0 V, f = 1 MHz, I _F = 5 mA		65		pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	IFC	IOFF = 10 μA	_	1	3	mA
Return LED current	l _{FT}	ION = 120 mA	0.1	_	_	mA
On-state resistance	Ron	I _{ON} = 120 mA		15	25	Ω

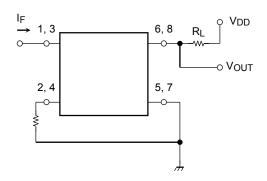
Isolation Characteristics (Ta = 25°C)

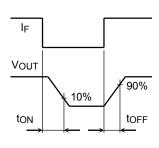
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V _S = 500 V, R.H. ≤ 60%	5 × 10 ¹⁰	10 ¹⁴	_	Ω
	AC, 1 minute BVs AC, 1 second, in oil	AC, 1 minute	1500	_	_	\/rma
Isolation voltage		_	3000	_	Vrms	
		DC, 1 minute, in oil	_	3000		Vdc

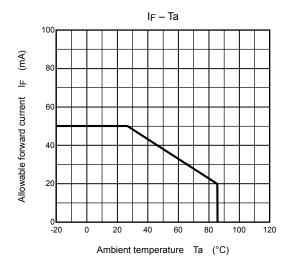
Switching Characteristics (Ta = 25°C)

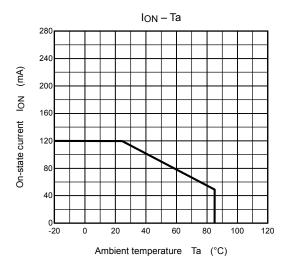
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	$R_L = 200 \Omega$ (Note 2)	_	_	1	ms
Turn-off time	toff	$V_{DD} = 20 \text{ V, I}_{F} = 5 \text{ mA}$	_	_	3	ms

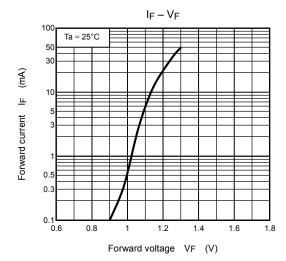
Note 2: Switching time test circuit

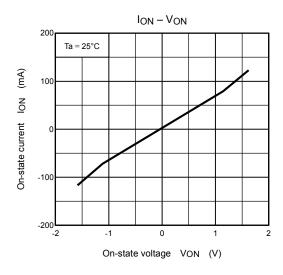


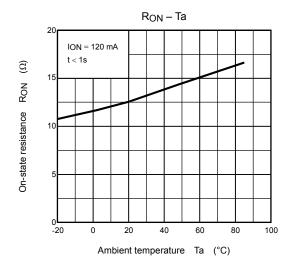


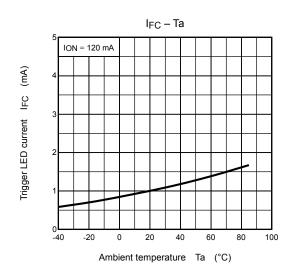




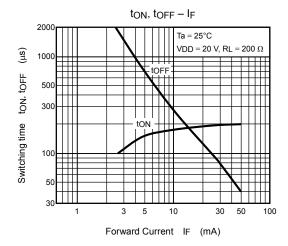


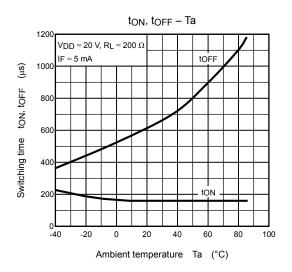


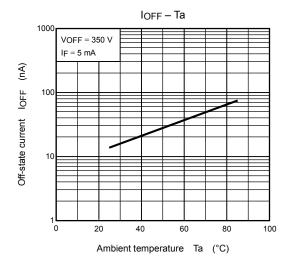




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